DMTH8004LPSW

80V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D Tc = +25°C (Package Limited)
80V	3.8mΩ @ V _{GS} = 10V	100A
000	5.3mΩ @ V _{GS} = 4.5V	100A

Description and Applications

This new generation MOSFET is designed to minimize RDS(ON) yet maintain superior switching performance. This device is ideal for use in power management and load switches.

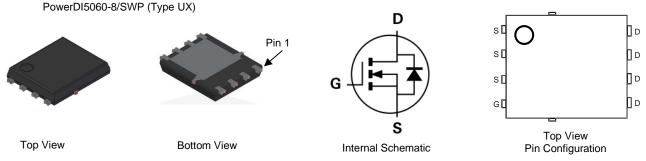
- **DC-DC** converters
- Load switches

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production -• Ensures More Reliable and Robust End Application
- **High Conversion Efficiency**
- Low RDS(ON) Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8 •
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

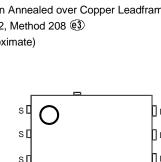
Part Number	Package	Packing		
Part Number	Package	Qty.	Carrier	
DMTH8004LPSW-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

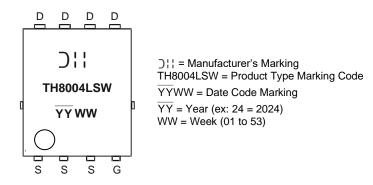
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.







Marking Information



Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristi	Symbol	Value	Unit		
Drain-Source Voltage	Vdss	80	V		
Gate-Source Voltage	Vgss	±20	V		
Continuous Drain Current, V _{GS} = 10V (Note 5)	ID	100 100	A		
Maximum Continuous Body Diode Forward Current (Note 5)			ls	83	А
Pulsed Drain Current (10µs Pulse, Duty Cycle =	Ідм	400	А		
Pulsed Body Diode Forward Current (10µs Pulse	lsм	400	А		
Avalanche Current, L = 0.3mH (Note 6)			las	35	А
Avalanche Energy, L = 0.3mH (Note 6)			Eas	183.7	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 7)	T _A = +25°C	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Reja	101	°C/W
Total Power Dissipation (Note 8)	T _A = +25°C	PD	2.9	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	Reja	51	°C/W
Total Power Dissipation (Note 5)	T _C = +25°C	PD	125	W
Thermal Resistance, Junction to Case (Note 5)		Rejc	1.2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes: 5. Thermal resistance from junction to soldering point (on the exposed drain pad).

6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.

7. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
8. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



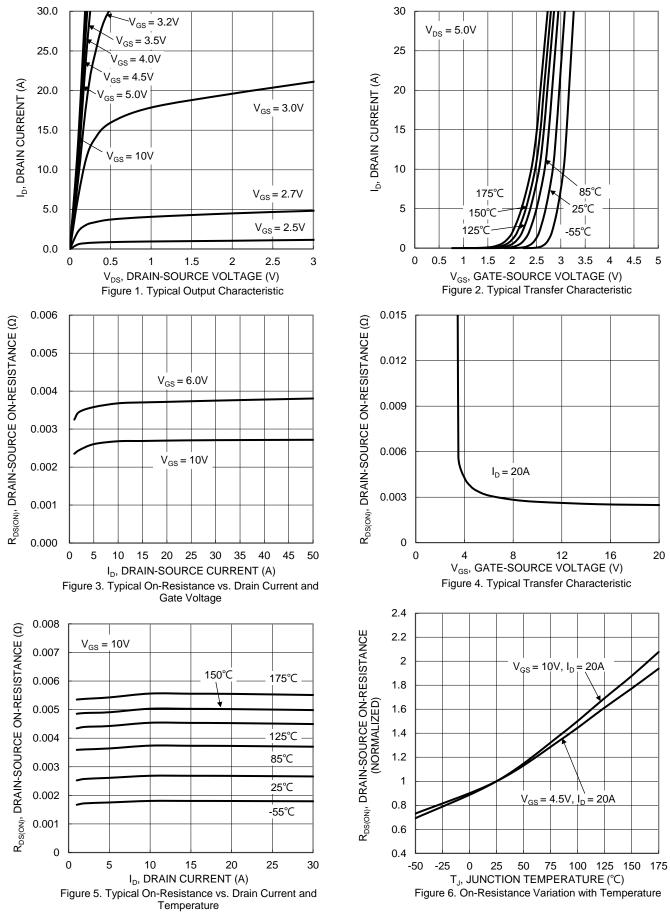
Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	80	—		V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	—	—	1	μA	$V_{DS} = 64V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	—	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	Vgs(th)	1.3	_	2.8	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Deserve	—	2.8	3.8	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	3.9	5.3	11122	$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	Vsd	_	0.8	1.2	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	—	4979	—		$V_{DS} = 40V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	—	1166	—	pF		
Reverse Transfer Capacitance	Crss	—	71	—			
Gate Resistance	Rg	_	2.1	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	43	—			
Total Gate Charge (V _{GS} = 10V)	Qg	—	81	—	nC	V _{DD} = 40V, I _D = 20A	
Gate-Source Charge	Qgs	—	14	—	no	VDD = 40V, ID = 20A	
Gate-Drain Charge	Q _{gd}	—	22	—			
Turn-On Delay Time	td(on)	—	8.5	—			
Turn-On Rise Time	t _R	_	11.8	_	20	$V_{DD} = 40V, V_{GS} = 10V$	
Turn-Off Delay Time	td(OFF)	—	55	—	ns	$I_D = 20A, R_G = 1.6\Omega$	
Turn-Off Fall Time	tF	_	27.7				
Body Diode Reverse Recovery Time	t _{RR}	_	53		ns		
Body Diode Reverse Recovery Charge	Qrr	_	91	_	nC	IF = 20A, di/dt = 100A/µs	

Notes: 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



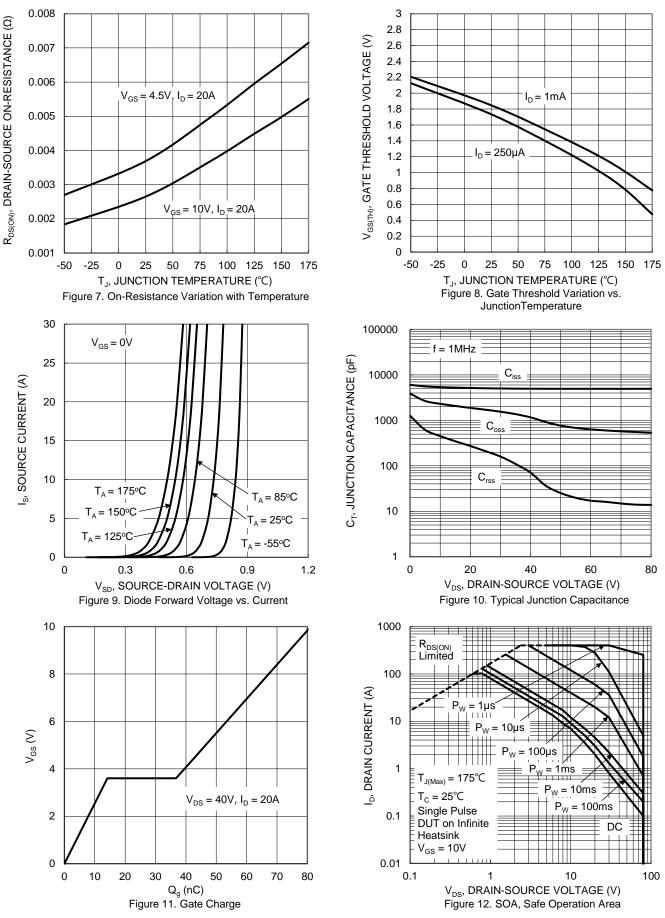
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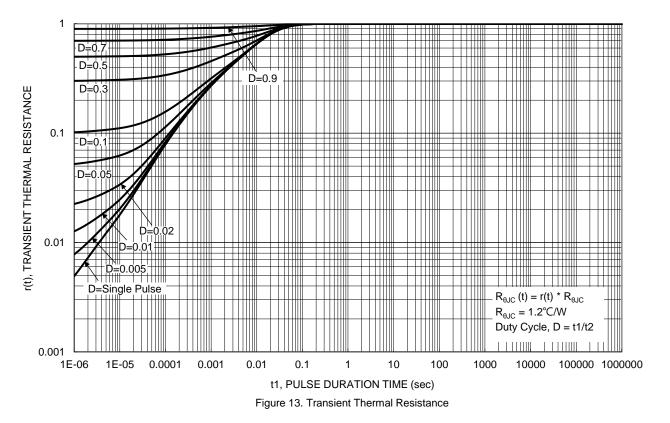


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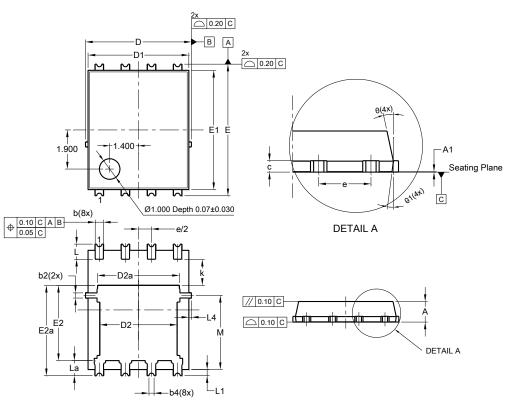


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Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



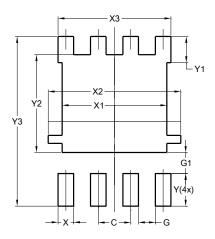
PowerDI5060-8/SWP (Type UX)

Po	PowerDI5060-8/SWP (Type UX)					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF	-			
С	0.230	0.330	0.277			
D	5	.15 BS0	2			
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78 4.18		3.98			
E	6	.40 BS0	0			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е		.27BSC)			
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
Х	0.610 4.100			
X1				
X2	5.190			
X3	4.420			
Y	1.270			
Y1	1.020			
Y2	3.810			
Y3	6.610			



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